

# HAT2042T

Silicon N Channel Power MOS FET  
High Speed Power Switching

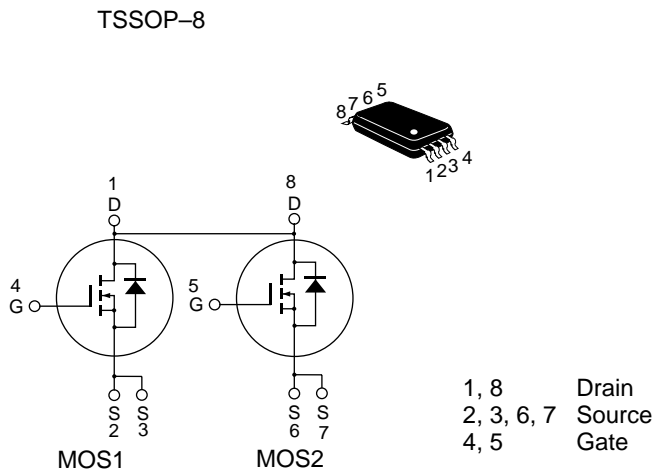
# HITACHI

ADE-208-669F (Z)  
7th. Edition  
February 1999

## Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

## Outline



## Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	28	V
Gate to source voltage	$V_{GSS}$	± 12	V
Drain current	$I_D$	5.0	A
Drain peak current	$I_{D(pulse)}$ <sup>Note1</sup>	40	A
Body-drain diode reverse drain current	$I_{DR}$	5.0	A
Channel dissipation	Pch <sup>Note2</sup>	1.0	W
Channel dissipation	Pch <sup>Note3</sup>	1.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	- 55 to + 150	°C

Note: 1.  $PW \leq 10 \mu s$ , duty cycle  $\leq 1\%$

2. 1 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm),  $PW \leq 10 s$

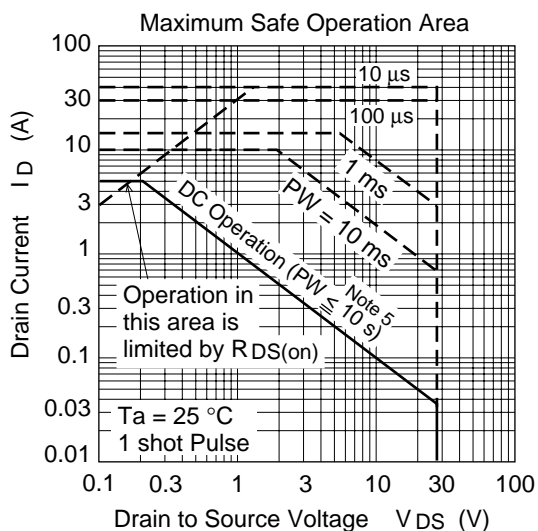
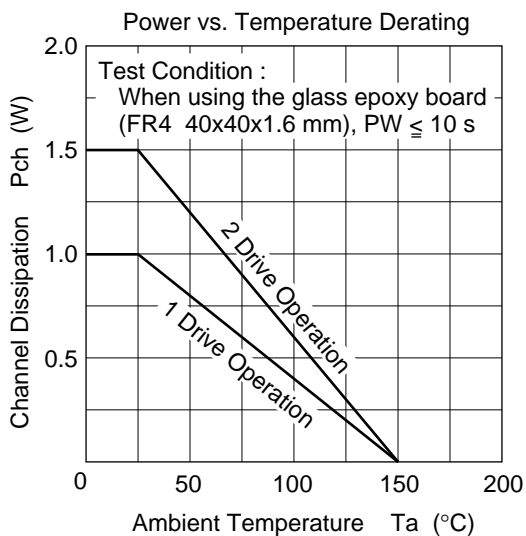
3. 2 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm),  $PW \leq 10 s$

## Electrical Characteristics (Ta = 25°C)

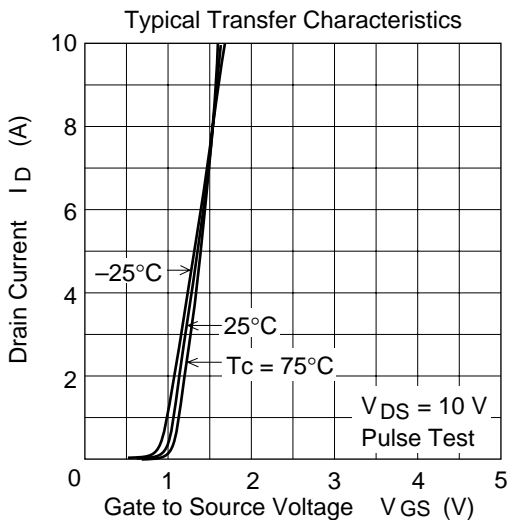
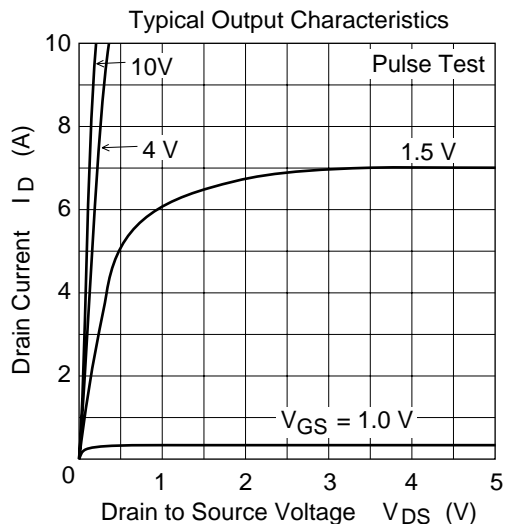
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	28	—	—	V	$I_D = 10mA, V_{GS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	± 0.1	μA	$V_{GS} = \pm 12 V, V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	1	μA	$V_{DS} = 28 V, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$V_{DS} = 10 V, I_D = 1 mA$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.027	0.034	Ω	$I_D = 3 A, V_{GS} = 4 V$ <sup>Note4</sup>
	$R_{DS(on)}$	—	0.037	0.044	Ω	$I_D = 3 A, V_{GS} = 2.5 V$ <sup>Note4</sup>
Forward transfer admittance	$ y_{fs} $	7	11	—	S	$I_D = 3 A, V_{DS} = 10 V$ <sup>Note4</sup>
Input capacitance	Ciss	—	510	—	pF	$V_{DS} = 10 V$
Output capacitance	Coss	—	190	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	140	—	pF	f = 1 MHz
Total gate charge	Qg	—	8.5	—	nc	$V_{DD} = 10 V$
Gate to source charge	Qgs	—	4.5	—	nc	$V_{GS} = 4 V$
Gate to drain charge	Qgd	—	4	—	nc	$I_D = 5 A$
Turn-on delay time	$t_{d(on)}$	—	14	—	ns	$V_{GS} = 4 V, I_D = 3 A$
Rise time	$t_r$	—	120	—	ns	$V_{DD} \cong 10 V$
Turn-off delay time	$t_{d(off)}$	—	85	—	ns	
Fall time	$t_f$	—	120	—	ns	
Body–drain diode forward voltage	$V_{DF}$	—	0.85	1.1	V	$IF = 5.0 A, V_{GS} = 0$ <sup>Note4</sup>
Body–drain diode reverse recovery time	$t_{rr}$	—	40	—	ns	$IF = 5.0 A, V_{GS} = 0$ $diF/dt = 20 A/\mu s$

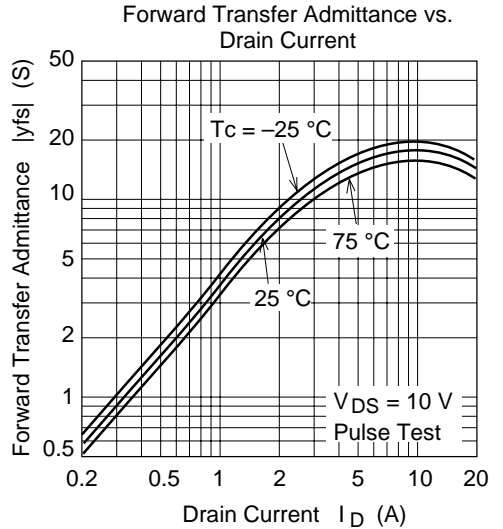
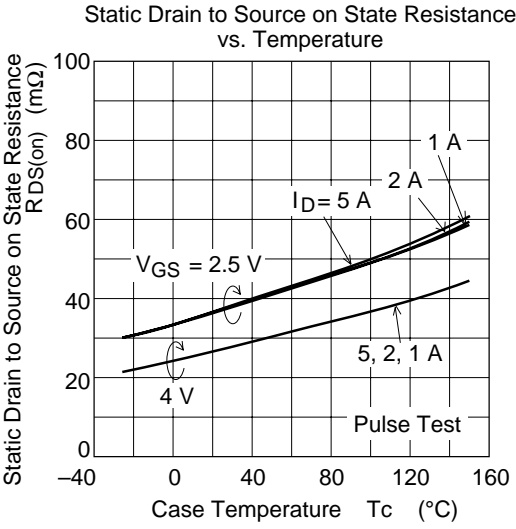
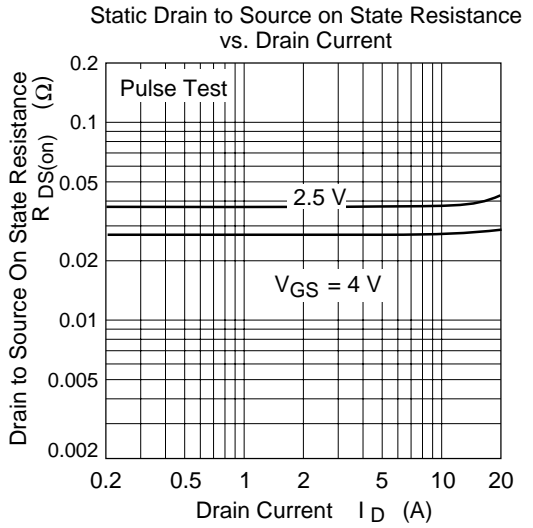
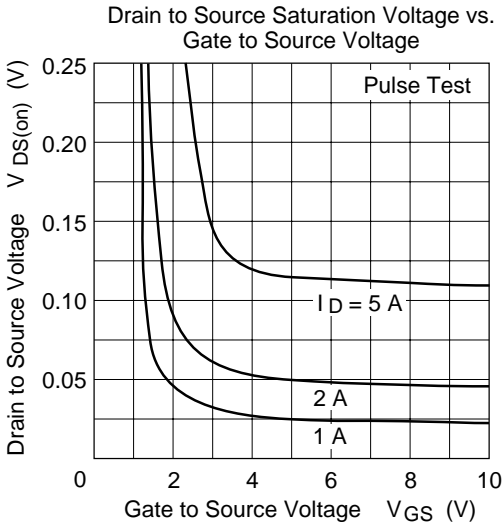
Note: 4. Pulse test

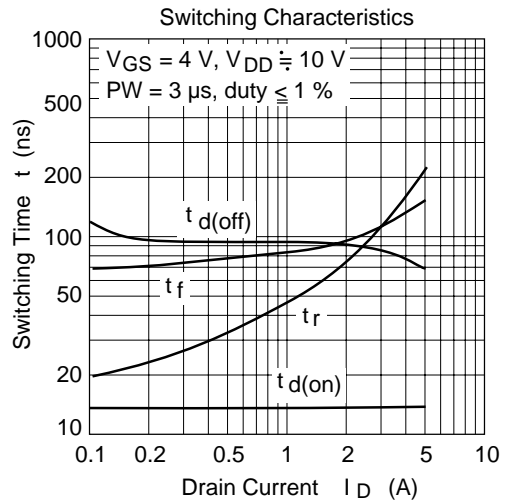
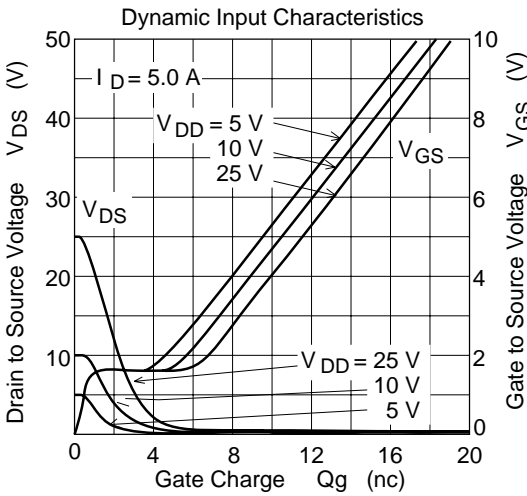
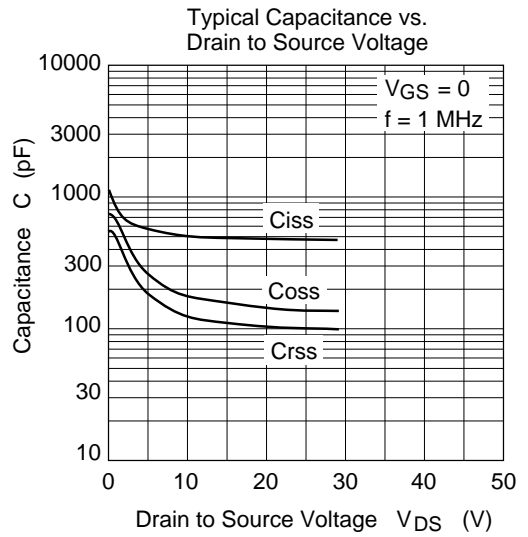
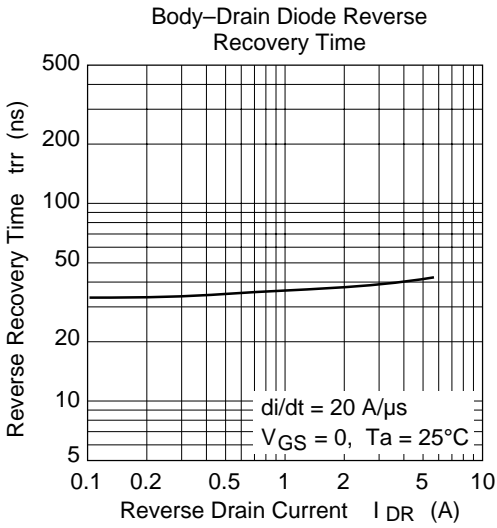
Main Characteristics

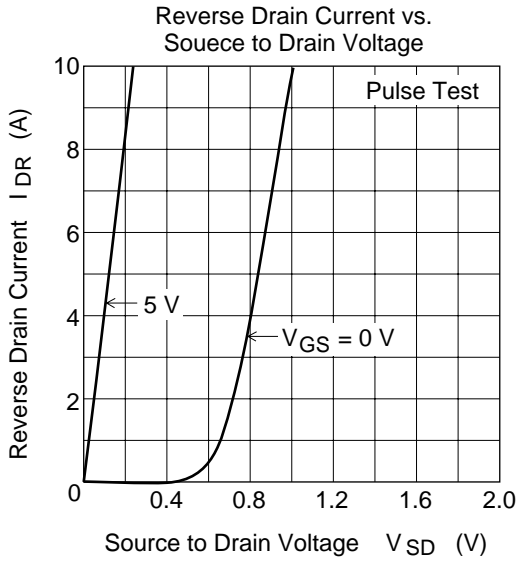


Note 5 :  
When using the glass epoxy board  
(FR4 40x40x1.6 mm)

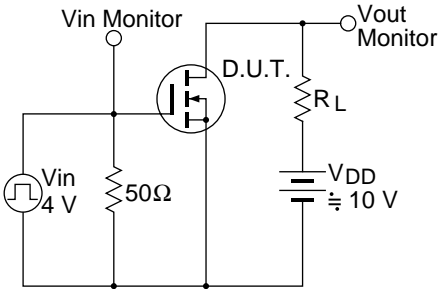




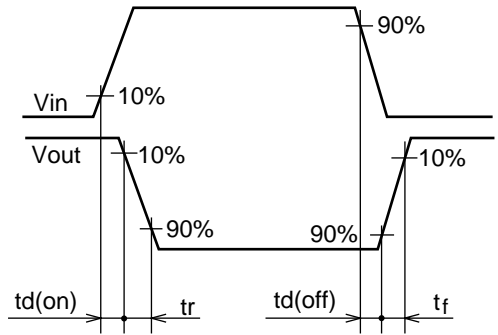




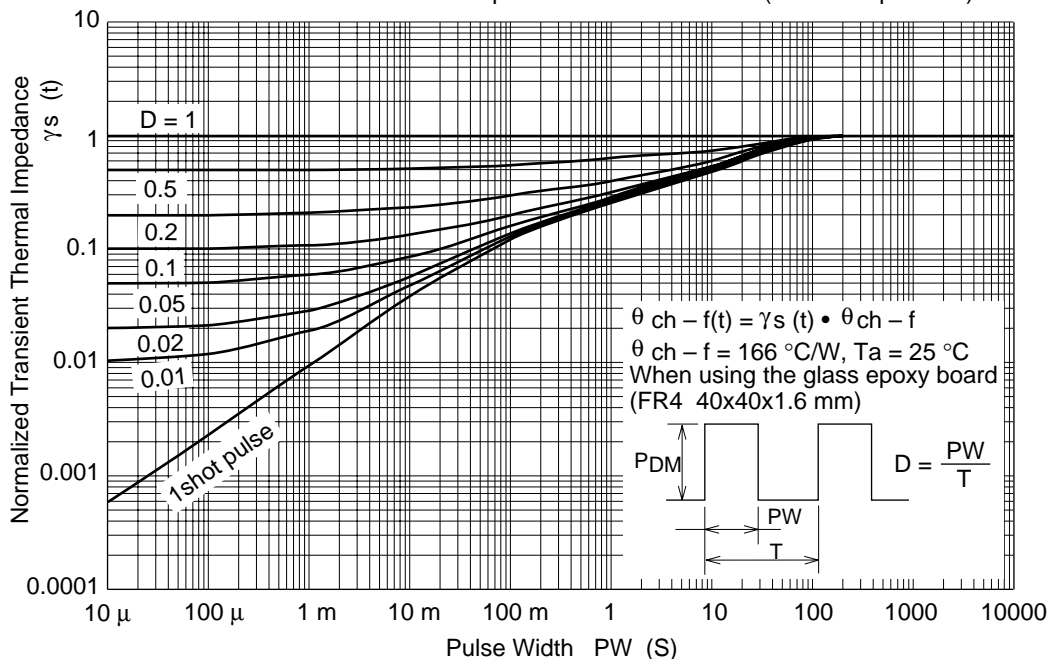
Switching Time Test Circuit



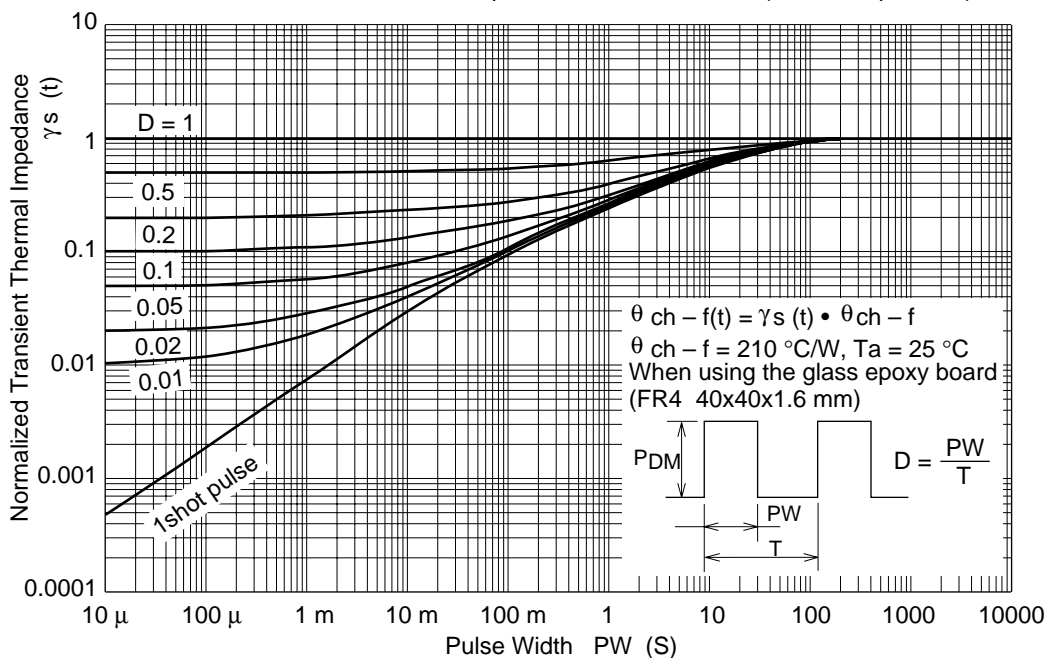
Switching Time Waveform



Normalized Transient Thermal Impedance vs. Pulse Width ( 1 Drive Operation)

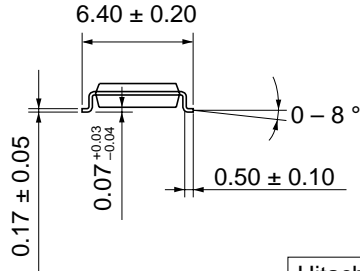
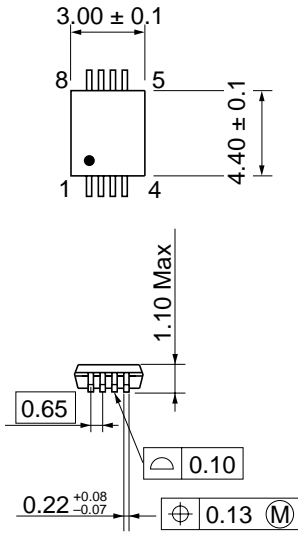


Normalized Transient Thermal Impedance vs. Pulse Width ( 2 Drive Operation)



## Package Dimensions

Unit: mm



Hitachi code	TTP-8D
EIAJ	—
JEDEC	—



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